



Product Change Notification - SYST-10BDNJ591

Date:

11 Jul 2019

Product Category:

8-bit Microcontrollers

Affected CPNs:



Notification subject:

ERRATA - PIC16(L)F15325/45 Family Silicon Errata and Data Sheet Clarification

Notification text:

SYST-10BDNJ591

Microchip has released a new DeviceDoc for the PIC16(L)F15325/45 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at [PIC16\(L\)F15325/45 Family Silicon Errata and Data Sheet Clarification](#).

Notification Status: Final

Description of Change: Updated Table 2, section 3. Module: Windowed Watchdog Timer (WWDT), section 5. Module: Electrical Specifications, added new section 6. Module: Master Synchronous Serial Port (MISSP), Added Section 8.1: Digital-to-Analog, Section 9.1: Reference Clock Output Module.

Data Sheet Clarifications:

Added Module 1: Table 36.3 Instruction Set

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 11 Jul 2019

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachment(s):

[PIC16\(L\)F15325/45 Family Silicon Errata and Data Sheet Clarification](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN)

PIC16F15325-E/JQ
PIC16F15325-E/JQVAO
PIC16F15325-E/P
PIC16F15325-E/SL
PIC16F15325-E/SLVAO
PIC16F15325-E/ST
PIC16F15325-I/JQ
PIC16F15325-I/P
PIC16F15325-I/SL
PIC16F15325-I/ST
PIC16F15325T-E/JQVAO
PIC16F15325T-E/SLVAO
PIC16F15325T-E/STVAO
PIC16F15325T-I/JQ
PIC16F15325T-I/SL
PIC16F15325T-I/ST
PIC16F15345-E/GZ
PIC16F15345-E/GZVAO
PIC16F15345-E/P
PIC16F15345-E/SO
PIC16F15345-E/SS
PIC16F15345-I/GZ
PIC16F15345-I/P
PIC16F15345-I/SO
PIC16F15345-I/SS
PIC16F15345T-E/GZV01
PIC16F15345T-E/GZVAO
PIC16F15345T-E/SSVAO
PIC16F15345T-I/GZ
PIC16F15345T-I/SO
PIC16F15345T-I/SS
PIC16LF15325-E/JQ
PIC16LF15325-E/P
PIC16LF15325-E/SL
PIC16LF15325-E/ST
PIC16LF15325-I/JQ
PIC16LF15325-I/P
PIC16LF15325-I/SL
PIC16LF15325-I/ST
PIC16LF15325/SD02
PIC16LF15325T-E/JQV02
PIC16LF15325T-E/JQVAO
PIC16LF15325T-E/STV03
PIC16LF15325T-E/STVAO
PIC16LF15325T-I/JQ
PIC16LF15325T-I/SL

PIC16LF15325T-I/ST
PIC16LF15345-E/6NVAO
PIC16LF15345-E/GZ
PIC16LF15345-E/P
PIC16LF15345-E/SO
PIC16LF15345-E/SS
PIC16LF15345-I/GZ
PIC16LF15345-I/P
PIC16LF15345-I/SO
PIC16LF15345-I/SS
PIC16LF15345-I/SSVAO
PIC16LF15345T-E/6NVAO
PIC16LF15345T-E/GZVAO
PIC16LF15345T-E/SS
PIC16LF15345T-I/GZ
PIC16LF15345T-I/SO
PIC16LF15345T-I/SS
PIC16LF15345T-I/SSVAO

PIC16(L)F15325/45 Family Silicon Errata and Data Sheet Clarification

The PIC16(L)F15325/45 family devices that you have received conform functionally to the current Device Data Sheet (DS40001865D), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).

The errata described in this document will be addressed in future revisions of the PIC16(L)F15325/45 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (**A2**).

Data Sheet clarifications and corrections start on [page 6](#), following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate website (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
 - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
 - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon ().
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC16(L)F15325/45 silicon revisions are shown in [Table 1](#).

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾	
		A1	A2
PIC16F15325	30C6h	2001h	2002h
PIC16LF15325	30C7h	2001h	2002h
PIC16F15345	30C8h	2001h	2002h
PIC16LF15345	30C9h	2001h	2002h

Note 1: The Device IDs (DEVID and DEVREV) are located at addresses 8006h and 8005h, respectively. They are shown in hexadecimal in the format "DEVID DEVREV".

2: Refer to the "PIC16(L)F153XX Memory Programming Specification" (DS40001838) for detailed information on Device and Revision IDs for your specific device.

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary	Affected Revisions	
				A1	A2
Analog-to-Digital Converter (ADC)	ADC Positive Voltage Reference	1.1	Using FVR as the positive voltage reference to the ADC can cause missing codes in the conversion result.	X	X
Development Support	Data Breakpoints	2.1	Data breakpoints are not available on Banks 59 through 63.	X	
Windowed Watchdog Timer (WWDT)	Watchdog Timer Clock Source	3.1	WWDT does not work with SOSC as the clock source.	X	
	Window Operation in DOZE mode	3.2	Window feature of the WWDT does not operate correctly in DOZE mode.	X	X
I/O Ports	SMBus mode	4.1	SMBus levels are not functional on RB4 and RB6 PORT pins.	X	
	Slew Rate Control	4.2	Slew Rate Control feature does not exist on RB4 and RB6 PORT pins.	X	
Electrical Specifications	SMBus VIL	5.1	The maximum VIL level changes when VDD is below 4.0V.	X	
	Fixed Voltage Reference (FVR) Accuracy	5.2	Fixed Voltage Reference (FVR) output tolerance may be higher than specified at temperatures below -20°C.	X	X
	Minimum VDD Specification for LF Devices	5.3	VDD Min for LF devices is 2.0V.	X	X
Master Synchronous Serial Port (MSSP)	SPI Slave mode	6.1	SSPBUF transmit shift register may be corrupted under certain conditions.	X	X
Nonvolatile Memory	WRERR Bit Operation	7.1	When performing a NVM high-voltage operation, if a Reset is issued in the middle of the operation, the WRERR bit is set. Then, if the user clears the WRERR bit and a Reset occurs again, this sets the WRERR bit because the internal latch has not been cleared earlier.	X	X
Digital-to-Analog (DAC)	Debug mode	8.1	FVR as the positive voltage source is not functional in Debug mode.	X	X
Reference Clock Output Module (CLKR)	CLKR Output	9.1	First output pulse of Reference Clock Output modul is incorrect when CLKREN is enabled.	X	X

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (A2).

1. Module: Analog-to-Digital Converter (ADC)

1.1 ADC Positive Voltage Reference

Using the FVR as the positive voltage reference to the ADC can cause an increase in missing codes.

Work around

1. Increase the bit conversion time, known as TAD, to 8 us.
2. Use VDD as the positive voltage reference to the ADC.

Affected Silicon Revisions

A1	A2							
X	X							

2. Module: Development Support

2.1 Data Breakpoints

Data breakpoints are not available on Banks 59 through 63. Any breakpoints that are placed in Banks 59 through 63 will fail to be recognized.

Work around

None.

Affected Silicon Revisions

A1	A2							
X								

3. Module: Windowed Watchdog Timer (WWDT)

3.1 WWDT Clock Source Selection

When the WDTCS [2:0] bits of the WDTCON1 register are set to 'b010', selecting the Secondary Oscillator SOSC 32 kHz, as the clock source, the WWDT does not operate.

Work around

Use the LFINTOSC or MFINTOSC clock sources for the WWDT.

Affected Silicon Revisions

A1	A2							
X								

3.2 Window Feature of the WWDT Does Not Operate Correctly in DOZE Mode

When the Windowed mode of operation is enabled in DOZE mode, a window violation error is issued even though the window is open and has been armed. This condition occurs only when the window size is set to a value other than 100% open.

Work around

1. Use the Windowed mode of operation in any other mode than DOZE. If disabling the DOZE mode is not an option, use the WWDT module without the window being enabled.
2. If the device is in DOZE mode, perform the arming process for the window in NORMAL mode, and return to the DOZE mode.
3. If there is an ISR in the application code, the arming within the window can be done inside the ISR with the ROI bit of the CPUDOZE register being set.

Affected Silicon Revisions

A1	A2							
X	X							

4. Module: I/O Ports

4.1 SMBus Mode

The SMBus signal levels are not available for the I²C functions of pins RB4 and RB6.

Standard ST and TTL levels are still available for these pins, which are configurable through the INLVLB register settings.

Work around

Use the Peripheral Pin Select (PPS) feature and move the required I²C functions to PORTC where the SMBus levels are still available.

Affected Silicon Revisions

A1	A2							
X								

4.2 Slew Rate Control

The Slew Rate Control feature is not available on pins RB4 and RB6.

Work around

Use other available PORT pins when slew rate control is required.

Affected Silicon Revisions

A1	A2							
X								

5. Module: Electrical Specifications

5.1 SMBus V_{IL} Level

When the V_{DD} voltage level supplied to the device is 4.0V and above, the maximum SMBus voltage level for the V_{IL} parameter is 0.8V. When V_{DD} drops below 4.0V, the maximum SMBus voltage level for V_{IL} drops to 0.7V.

Work around

None.

Affected Silicon Revisions

A1	A2						
X							

5.2 Fixed Voltage Reference (FVR) Accuracy

At temperatures below -20°C, the output voltage for the FVR may be greater than the level specified in the data sheet. This will apply to all three gain amplifier settings, (1X, 2X, 4X). The affected parameter numbers found in the data sheet are: FVR01 (1X gain setting), FVR02 (2X gain setting), and FVR03 (4X gain setting).

Work around

None.

Affected Silicon Revisions

A1	A2						
X	X						

5.3 Minimum V_{DD} Specification for LF Devices

Nonvolatile memory (NVM) access on LF devices may not work when operating at temperatures between -40°C and +25°C and V_{DD} levels below 2.0V. V_{DD_MIN} for parameter (D002) is 2.0V for temperatures between -40°C and 25°C.

Work around

None.

Affected Silicon Revisions

A1	A2						
X	X						

6. Module: Master Synchronous Serial Port (MSSP)

6.1 SSPBUF May Become Corrupted

When operating in SPI Slave mode, if the incoming SCK clock signal arrives during any of the conditions below, the SSPBUF transmit shift register may become corrupted. The transmitted slave byte cannot be ensured to be correct, and the state of the WCOL bit may or may not indicate a write collision.

These conditions include:

- A write to an SFR
- A write to RAM following an SFR read
- A write to RAM prior to an SFR read

Work around

Method 1 (Interrupt Based Using \overline{SS}):

1. Connect the \overline{SS} line to both the \overline{SS} input and either an INT or IOC input pin.
2. Enable INT or IOC interrupts (interrupt on falling edge if available, otherwise check that $\overline{SS} == 0$ when the interrupt occurs).
3. Load SSPBUF with the data to be transmitted.
4. Continue program execution.
5. When the Interrupt Service Routine (ISR) is invoked, do either of the following:

- Add a delay that ensures the first SCK clock will be complete, or
- Poll SSPSTAT.BF (while(BF == 0)) and wait for the transmission/reception to complete.

Once either of these are complete, it is safe to return to program execution.

Method 2 (Bit Polling Based Using \overline{SS}):

1. Load SSPBUF with the data to be transmitted.
 2. Poll the \overline{SS} line and wait for the \overline{SS} to go active (while(!PORTx.nSS == 0)).
 3. When \overline{SS} is active ($\overline{SS} == 0$), do either of the following:
- Add a delay that ensures the first SCK clock will be complete, or
 - Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

Once one of these two methods are complete, it is safe to return to program execution.

Method 3 (\overline{SS} not Available):

1. Load SSPBUF with the data to be transmitted.
2. Poll SSPSTAT.BF (while(BF == 0)), and wait for the transmission/reception to complete.

Affected Silicon Revisions

A1	A2						
X	X						

7. Module: Nonvolatile Memory

7.1 WRERR Bit Operation

When a Reset is issued while an NVM high-voltage operation is in progress, the WRERR bit in the NVMCON1 register is set as expected. After clearing the WRERR bit, if a Reset reoccurs, the WRERR bit is set again regardless of whether an NVM operation is in progress or not. A successful write operation will clear the WRERR condition.

Work around

None.

Affected Silicon Revisions

A1	A2						
X	X						

8. Module: Digital-to-Analog (DAC)

8.1 FVR as the Positive Voltage Source is Not Functional in Debug Mode

When using the DAC module while in Debug mode, and selecting the FVR as the positive voltage source, DAC1PSS = 10, the DAC is not functional and unexpected results can be seen on the output.

Work around

None.

Affected Silicon Revisions

A1	A2						
X	X						

9. Module: Reference Clock Output Module (CLKR)

9.1 First Output Pulse of Reference Clock Output Module is Incorrect When CLKREN is Enabled

If CLKREN bit is set by the user, the number of input clock cycles taken to generate the reference clock output might vary by one cycle due to a race condition. This condition occurs only if LCx_out or NCOx_out are the inputs (CLKRCLK bits) to the CLKR module.

Work around

Ignore the first output pulse of the CLKR output signal.

Affected Silicon Revisions

A1	A2						
X	X						

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001865D):

Note: Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

1. Module: Table 36.3 Instruction Set Literal Operations

LITERAL OPERATIONS								
ADDLW	k	Add literal and W	1	11	1110	kkkk	kkkk	C, DC, Z
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z
MOVLB	k	Move literal to BSR	1	00	0001	01kk	kkkk	
MOVLP	k	Move literal to PCLATH	1	11	0001	1kkk	kkkk	
MOVLW	k	Move literal to W	1	11	0000	kkkk	kkkk	
SUBLW	k	Subtract W from literal	1	11	1100	kkkk	kkkk	C, DC, Z
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z

APPENDIX A: DOCUMENT REVISION HISTORY

Rev B Document (07/2019)

Updated Table 2, section 3. Module: Windowed Watchdog Timer (WWDT), section 5. Module: Electrical Specifications, added new section 6. Module: Master Synchronous Serial Port (MISSP), Added Section 8.1: Digital-to-Analog, Section 9.1: Reference Clock Output Module,

Data Sheet Clarifications:

Added Module 1: Table 36.3 Instruction Set

Rev A Document (12/2016)

Initial release of this document.

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as “unbreakable.”

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Klear, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PackeTime, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TempTracker, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, FlashTec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, Vite, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, INICnet, Inter-Chip Connectivity, JitterBlocker, KlearNet, KlearNet logo, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICKit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2016-2019, Microchip Technology Incorporated, All Rights Reserved.

ISBN: 978-1-5224-4763-4

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



MICROCHIP

Worldwide Sales and Service

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200
Fax: 480-792-7277
Technical Support:
<http://www.microchip.com/support>
Web Address:
www.microchip.com

Atlanta

Duluth, GA
Tel: 678-957-9614
Fax: 678-957-1455

Austin, TX

Tel: 512-257-3370

Boston

Westborough, MA
Tel: 774-760-0087
Fax: 774-760-0088

Chicago

Itasca, IL
Tel: 630-285-0071
Fax: 630-285-0075

Dallas

Addison, TX
Tel: 972-818-7423
Fax: 972-818-2924

Detroit

Novi, MI
Tel: 248-848-4000

Houston, TX

Tel: 281-894-5983

Indianapolis

Noblesville, IN
Tel: 317-773-8323
Fax: 317-773-5453
Tel: 317-536-2380

Los Angeles

Mission Viejo, CA
Tel: 949-462-9523
Fax: 949-462-9608
Tel: 951-273-7800

Raleigh, NC

Tel: 919-844-7510

New York, NY

Tel: 631-435-6000

San Jose, CA

Tel: 408-735-9110
Tel: 408-436-4270

Canada - Toronto

Tel: 905-695-1980
Fax: 905-695-2078

ASIA/PACIFIC

Australia - Sydney
Tel: 61-2-9868-6733

China - Beijing
Tel: 86-10-8569-7000

China - Chengdu
Tel: 86-28-8665-5511

China - Chongqing
Tel: 86-23-8980-9588

China - Dongguan
Tel: 86-769-8702-9880

China - Guangzhou
Tel: 86-20-8755-8029

China - Hangzhou
Tel: 86-571-8792-8115

China - Hong Kong SAR
Tel: 852-2943-5100

China - Nanjing
Tel: 86-25-8473-2460

China - Qingdao
Tel: 86-532-8502-7355

China - Shanghai
Tel: 86-21-3326-8000

China - Shenyang
Tel: 86-24-2334-2829

China - Shenzhen
Tel: 86-755-8864-2200

China - Suzhou
Tel: 86-186-6233-1526

China - Wuhan
Tel: 86-27-5980-5300

China - Xian
Tel: 86-29-8833-7252

China - Xiamen
Tel: 86-592-2388138

China - Zhuhai
Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore
Tel: 91-80-3090-4444

India - New Delhi
Tel: 91-11-4160-8631

India - Pune
Tel: 91-20-4121-0141

Japan - Osaka
Tel: 81-6-6152-7160

Japan - Tokyo
Tel: 81-3-6880-3770

Korea - Daegu
Tel: 82-53-744-4301

Korea - Seoul
Tel: 82-2-554-7200

Malaysia - Kuala Lumpur
Tel: 60-3-7651-7906

Malaysia - Penang
Tel: 60-4-227-8870

Philippines - Manila
Tel: 63-2-634-9065

Singapore
Tel: 65-6334-8870

Taiwan - Hsin Chu
Tel: 886-3-577-8366

Taiwan - Kaohsiung
Tel: 886-7-213-7830

Taiwan - Taipei
Tel: 886-2-2508-8600

Thailand - Bangkok
Tel: 66-2-694-1351

Vietnam - Ho Chi Minh
Tel: 84-28-5448-2100

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4450-2828
Fax: 45-4485-2829

Finland - Espoo
Tel: 358-9-4520-820

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Garching
Tel: 49-8931-9700

Germany - Haan
Tel: 49-2129-3766400

Germany - Heilbronn
Tel: 49-7131-72400

Germany - Karlsruhe
Tel: 49-721-625370

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Germany - Rosenheim
Tel: 49-8031-354-560

Israel - Ra'anana
Tel: 972-9-744-7705

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Italy - Padova
Tel: 39-049-7625286

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Norway - Trondheim
Tel: 47-7288-4388

Poland - Warsaw
Tel: 48-22-3325737

Romania - Bucharest
Tel: 40-21-407-87-50

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

Sweden - Gothenberg
Tel: 46-31-704-60-40

Sweden - Stockholm
Tel: 46-8-5090-4654

UK - Wokingham
Tel: 44-118-921-5800
Fax: 44-118-921-5820